

Reference Specification

DEC Series
Lead Type Disc Ceramic Capacitors of DC6.3kV ratings for General Purpose

Product specifications in this catalog are as of Dec. 2017, and are subject to change or obsolescence without notice.

Please consult the approval sheet before ordering. Please read rating and Cautions first.

⚠ CAUTION

1. OPERATING VOLTAGE

When DC-rated capacitors are to be used in AC or ripple current circuits, be sure to maintain the Vp-p value of the applied voltage or the Vo-p which contains DC bias within the rated voltage range. When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use a capacitor within rated voltage containing these irregular voltage.

When DC-rated capacitors are to be used in input circuits from commercial power source (AC filter), be sure to use Safety Recognized Capacitors because various regulations on withstand voltage or impulse withstand established for each equipment should be taken into considerations.

| Voltage | DC Voltage | DC+AC Voltage | AC Voltage | Pulse Voltage(1) | Pulse Voltage(2) |
|---------------------------|------------|---------------|------------|------------------|------------------|
| Positional Measurement | Vo-p | Vo-p | Vp-p | Vp-p | Vp-p |

2. OPERATING TEMPERATURE AND SELF-GENERATED HEAT

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself. When the capacitor is used in high-frequency current, pulse current or similar current, it may self- generate heat due to dielectric-loss. The frequency of the applied sine wave voltage should be less than 300kHz. The applied voltage load(*) should be such that the capacitor's self-generated heat is within 20 °C at the atmosphere temperature of 25 °C. When measuring, use a thermocouple of small thermal capacity-K of ϕ 0.1mm in conditions where the capacitor is not affected by radiant heat from other components or surrounding ambient fluctuations. Excessive heat may lead to deterioration of the capacitor's characteristics and reliability. (Never attempt to perform measurement with the cooling fan running. Otherwise, accurate measurement cannot be ensured.)

* Before using SL characteristic capacitor (low dissipation), be sure to read the instructions in item 4.

3. FAIL-SAFE

When capacitor would be broken, failure may result in a short circuit. Be sure to provide an appropriate fail-safe function like a fuse on your product if failure would follow an electric shock, fire or fume.

4. LOAD REDUCTION AND SELF-GENERATED HEAT DURING APPLICATION OF HIGH-FREQUENCY AND HIGH-VOLTAGE

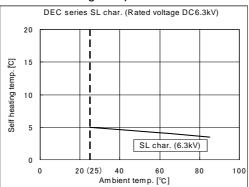
In the case of SL characteristic capacitors, due to the low self-heating characteristics of low-dissipation capacitor, the allowable electric power is much higher than the general B characteristic. However, in case the self-heating temperature is 20 °C under a high-frequency voltage whose peak-to-peak value equals the

capacitors rated voltage, the capacitors power consumption may exceeded it's allowable electric power. Therefore, when using the SL characteristic capacitors in a high-frequency and high-voltage circuit with a frequency of 1kHz or higher, make sure that the Vp-p values including the DC bias, do not exceed the applied voltage value specified in Table 1. Also make sure that the self-heating temperature (the difference between the capacitor's surface temperature and the capacitor's ambient temperature) at an ambient temperature of 25 °C does not exceed the value specified in Table 1.

As shown in Fig. 1, the self-heating temperature depends on the ambient temperature. Therefore, if you are not able to set the ambient temperature to approximately 25 °C, please contact our sales representatives or product engineers.

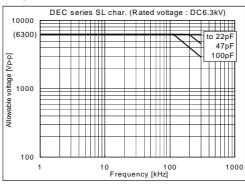
| Tomp | DC Rated | Allowable Condi | tions at High-frequency *3 | Capacitor's |
|--------|----------|-----------------|----------------------------|---------------|
| Char. | | Applied Voltage | Ambient | |
| Cilai. | vollage | (max.) | (25 °C Ambient Temp.) *1 | Temp. *2 |
| SL | 6.3kV | 6300Vp-p | 5 °C max. | -25 to +85 °C |

- *1 When the ambient temperature is 85 to 125 °C, the applied voltage needs to be further reduced. If the low-dissipation capacitors need to be used at an ambient temperature of 85 to 125 °C, please contact our sales representatives or product engineers.
- *2 Fig. 2 shows reference data on the allowable voltage-frequency characteristic for a sine wave voltage. <Fig. 1> Dependence of Self-heating Temperature on Ambient Temperature



<Fig. 2> Allowable Voltage (Sine Wave Voltage) – Frequency Characteristic [At Ambient Temperature of 85 °C or less]

Because of the influence of harmonics, when the applied voltage is a rectangular wave or pulse wave voltage (instead of a sine wave voltage), the heat generated by the capacitor is higher than the value obtained by application of the sine wave with the same fundamental frequency. Roughly calculated for reference, the allowable voltage for a rectangular wave or pulse wave corresponds approximately to the allowable voltage for a sine wave whose fundamental frequency is twice as large as that of the rectangular wave or pulse wave. This allowable voltage, however, varies depending on the voltage and current waveforms. Therefore, you are requested to make sure that the self-heating temperature is not higher than the value specified in Table 1.



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5. VIBRATION AND IMPACT

Do not expose a capacitor or its leads to excessive shock or vibration during use.

6. SOLDERING

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

When soldering capacitor with a soldering iron, it should be performed in following conditions.

Temperature of iron chip: 400 °C max. Soldering iron wattage: 50 W max. Soldering time: 3.5 s max.

7. BONDING, RESIN MOLDING AND COATING

In case of bonding, molding or coating this product, verify that these processes do not affect the quality of capacitor by testing the performance of the bonded, molded or coated product in the intended equipment.

In case of the amount of applications, dryness / hardening conditions of adhesives and molding resins containing organic solvents (ethyl acetate, methyl ethyl ketone, toluene, etc.) are unsuitable, the outer coating resin of a capacitor is damaged by the organic solvents and it may result, worst case, in a short circuit.

The variation in thickness of adhesive, molding resin or coating may cause a outer coating resin cracking and/or ceramic element cracking of a capacitor in a temperature cycling.

8. TREATMENT AFTER BONDING, RESIN MOLDING AND COATING

When the outer coating is hot (over 100 °C) after soldering, it becomes soft and fragile. So please be careful not to give it mechanical stress.

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

9. OPERATING AND STORAGE ENVIRONMENT

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors

in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed -10 to 40 °C and 15 to 85%. Use capacitors within 6 months after delivered.

Check the solderability after 6 months or more.

10. LIMITATION OF APPLICATIONS

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

- 1. Aircraft equipment
- 2. Aerospace equipment
- 3. Undersea equipment
- 4. Power plant control equipment
- 5. Medical equipment
- 6. Transportation equipment (vehicles, trains, ships, etc.)
- 7. Traffic signal equipment
- 8. Disaster prevention / crime prevention equipment
- 9. Data-processing equipment exerting influence on public
- 10. Application of similar complexity and/or reliability requirements to the applications listed in the above.

NOTICE

1. CLEANING (ULTRASONIC CLEANING)

To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity: Output of 20 watts per liter or less.

Rinsing time: 5 min maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

2. CAPACITANCE CHANGE OF CAPACITORS

- Class 1 capacitors

Capacitance might change a little depending on a surrounding temperature or an applied voltage. Please contact us if you use for the strict time constant circuit.

- Class 2 and 3 capacitors

Class 2 and 3 capacitors like temperature characteristic B, E and F have an aging characteristic, whereby the capacitor continually decreases its capacitance slightly if the capacitor leaves for a long time.

Moreover, capacitance might change greatly depending on a surrounding temperature or an applied voltage. So, it is not likely to be able to use for the time constant circuit.

Please contact us if you need a detail information.

⚠ NOTE

- 1.Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- 2. You are requested not to use our product deviating from this specification.

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1. Application

This specification is applied to Lead Type Disc Ceramic Capacitors of DC6.3 kV ratings and Class1,2 of DEC series used for General Electric equipment.

Do not use these products in any automotive power train or safety equipment including battery chargers for electric vehicles and plug-in hybrids.

2. Rating

2-1. Operating temperature range

-25 ~ +85°C

2-2. Part number configuration

ex.) DEC B3 3J 102 K C4 B
Series Temperature Rated Capacitance Capacitance Capacitance tolerance code style code specification

•Temperature characteristic

| Code | Temperature characteristic |
|------|----------------------------|
| 1X | SL |
| В3 | В |
| E3 | Е |

Please confirm detailed specification on [Specification and test methods].

Rated voltage

| Code | Rated voltage |
|------|---------------|
| 3J | DC6.3kV |

Capacitance

The first two digits denote significant figures; the last digit denotes the multiplier of 10 in pF. ex.) In case of 102.

$$10 \times 10^2 = 1000 pF$$

• Capacitance tolerance

Please refer to [Part number list].

• Lead code

| Code | Lead style |
|------|--------------------------|
| A* | Vertical crimp long type |
| C* | Straight long type |

^{*} Please refer to [Part number list].

Solder coated copper wire is applied for termination.

• Packing style code

| Code | Packing type |
|------|--------------|
| В | Bulk type |

• Individual specification

In case part number cannot be identified without 'individual specification', it is added at the end of part number.

3. Marking

Temperature characteristic : Letter code (Omitted for char. SL, char. E and maximum body

diameter ϕ 9mm and under of char. B.)

Nominal capacitance : Actual value (under 100pF)

3 digit system (100pF and over)

Capacitance tolerance : Code

Rated voltage : Letter code (In case of DC6.3kV marked with 6KV)

(Omitted for maximum body diameter ϕ 9mm and under)

Manufacturing year : Letter code(The last digit of A.D. year.)

(Omitted for maximum body diameter ϕ 7mm and under)

Manufacturing month : Code(Omitted for maximum body diameter φ 7mm and under)

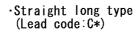
Feb./Mar. \rightarrow 2 Aug./Sep. \rightarrow 8 Apr./May \rightarrow 4 Oct./Nov. \rightarrow O Dec./Jan. \rightarrow D

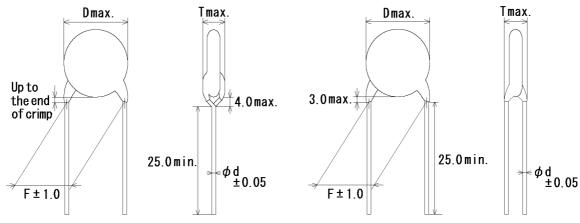
(Example)

B 102K 6KV (M 0D

4. Part number list

·Vertical crimp long type (Lead code:A*)



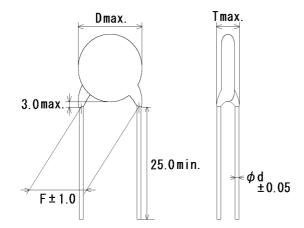


Note) The mark '*' of lead code differ from lead spacing(F) and lead diameter(d).
Please see the following list about details.

Unit · mm

| | | | | _ | | | | | | Unit : | mm |
|------|------|-----------|---------------------------|--------------------|--------------------|------|-------|-------|-----|--------|---------------|
| | Cap. | 0 (-1 | Out to the Book North and | Marata Bart Nambar | DC DC | Din | nensi | on (m | m) | Code | Pack |
| T.C. | (pF) | Cap. tol. | Customer Part Number | Murata Part Number | Rated Volt. (V) | D | Т | F | d | | qty. (pcs) |
| SL | 10 | ±5% | | DEC1X3J100JA3BMS1 | 6300 | 7.0 | 7.0 | 7.5 | 0.6 | A3 | 250 |
| SL | 10 | ±5% | | DEC1X3J100JC4BMS1 | 6300 | 7.0 | 7.0 | 10.0 | 0.6 | C4 | 250 |
| SL | 12 | ±5% | | DEC1X3J120JA3B | 6300 | 8.0 | 7.0 | 7.5 | 0.6 | A3 | 250 |
| SL | 12 | ±5% | | DEC1X3J120JC4B | 6300 | 8.0 | 7.0 | 10.0 | 0.6 | C4 | 250 |
| SL | 15 | ±5% | | DEC1X3J150JA3B | 6300 | 8.0 | 7.0 | 7.5 | 0.6 | A3 | 250 |
| SL | 15 | ±5% | | DEC1X3J150JC4B | 6300 | 8.0 | 7.0 | 10.0 | 0.6 | C4 | 250 |
| SL | 18 | ±5% | | DEC1X3J180JA3B | 6300 | 9.0 | 7.0 | 7.5 | 0.6 | A3 | 250 |
| SL | 18 | ±5% | | DEC1X3J180JC4B | 6300 | 9.0 | 7.0 | 10.0 | 0.6 | C4 | 250 |
| SL | 22 | ±5% | | DEC1X3J220JA3B | 6300 | 9.0 | 7.0 | 7.5 | 0.6 | A3 | 250 |
| SL | 22 | ±5% | | DEC1X3J220JC4B | 6300 | 9.0 | 7.0 | 10.0 | 0.6 | C4 | 250 |
| SL | 27 | ±5% | | DEC1X3J270JA3B | 6300 | 9.0 | 7.0 | 7.5 | 0.6 | A3 | 250 |
| SL | 27 | ±5% | | DEC1X3J270JC4B | 6300 | 9.0 | 7.0 | 10.0 | 0.6 | C4 | 250 |
| SL | 33 | ±5% | | DEC1X3J330JA3B | 6300 | 9.0 | 7.0 | 7.5 | 0.6 | A3 | 250 |
| SL | 33 | ±5% | | DEC1X3J330JC4B | 6300 | 9.0 | 7.0 | 10.0 | 0.6 | C4 | 250 |
| SL | 39 | ±5% | | DEC1X3J390JA3B | 6300 | 9.0 | 7.0 | 7.5 | 0.6 | A3 | 250 |
| SL | 39 | ±5% | | DEC1X3J390JC4B | 6300 | 9.0 | 7.0 | 10.0 | 0.6 | C4 | 250 |
| SL | 47 | ±5% | | DEC1X3J470JA3B | 6300 | 9.0 | 7.0 | 7.5 | 0.6 | A3 | 250 |
| SL | 47 | ±5% | | DEC1X3J470JC4B | 6300 | 9.0 | 7.0 | 10.0 | 0.6 | C4 | 250 |
| SL | 56 | ±5% | | DEC1X3J560JC4B | 6300 | 10.0 | 7.0 | 10.0 | 0.6 | C4 | 100 |
| SL | 68 | ±5% | | DEC1X3J680JC4B | 6300 | 12.0 | 7.0 | 10.0 | 0.6 | C4 | 100 |
| SL | 82 | ±5% | | DEC1X3J820JC4B | 6300 | 12.0 | 7.0 | 10.0 | 0.6 | C4 | 100 |
| SL | 100 | ±5% | | DEC1X3J101JC4B | 6300 | 13.0 | 7.0 | 10.0 | 0.6 | C4 | 100 |
| SL | 120 | ±5% | | DEC1X3J121JC4B | 6300 | 14.0 | 7.0 | 10.0 | 0.6 | C4 | 100 |
| SL | 150 | ±5% | | DEC1X3J151JC4B | 6300 | 15.0 | 7.0 | 10.0 | 0.6 | C4 | 100 |
| В | 100 | ±10% | | DECB33J101KC4B | 6300 | 9.0 | 7.0 | 10.0 | 0.6 | C4 | 250 |
| В | 150 | ±10% | | DECB33J151KC4B | 6300 | 9.0 | 7.0 | 10.0 | 0.6 | C4 | 250 |
| В | 220 | ±10% | | DECB33J221KC4B | 6300 | 9.0 | 7.0 | 10.0 | 0.6 | C4 | 250 |
| | • | | | | - | | | | | , | 1 |

·Straight long type (Lead code:C*)



Note) The mark '*' of lead code differ from lead spacing(F) and lead diameter(d).
Please see the following list about details.

Unit: mm

| | Offic: film | | | | | | | | | | |
|-----------|-------------|----------------------|----------------------|-------------------------------------|------|------|-------|-------|------|---------------|-----|
| T.C. Cap. | | Cap. tol. | Customer Part Number | DC D Murata Part Number Rated Volt. | | Dir | nensi | on (m | Lead | Pack | |
| 1.C. (pF) | Сар. тог. | Customer Fait Number | Murata Fait Number | (V) | D | Т | F | đ | Code | qty. (pcs) | |
| В | 330 | ±10% | | DECB33J331KC4B | 6300 | 9.0 | 7.0 | 10.0 | 0.6 | C4 | 250 |
| В | 470 | ±10% | | DECB33J471KC4B | 6300 | 10.0 | 7.0 | 10.0 | 0.6 | C4 | 100 |
| В | 680 | ±10% | | DECB33J681KC4B | 6300 | 11.0 | 7.0 | 10.0 | 0.6 | C4 | 100 |
| В | 1000 | ±10% | | DECB33J102KC4B | 6300 | 13.0 | 7.0 | 10.0 | 0.6 | C4 | 100 |
| Е | 1000 | +80/-20% | | DECE33J102ZC4B | 6300 | 11.0 | 7.0 | 10.0 | 0.6 | C4 | 100 |
| Е | 2200 | +80/-20% | | DECE33J222ZC4B | 6300 | 15.0 | 7.0 | 10.0 | 0.6 | C4 | 100 |

| No. | ecification and test | | Specification | Test method | | | |
|-----|---------------------------------|---------------------------|--|--|--|--|--|
| 1 | Appearance and o | | No marked defect on appearar form and dimensions. Please refer to [Part number li | nce The capacitor should be inspected by naked eyes for visible evidence of defect. | | | |
| 2 | Marking | | To be easily legible. | The capacitor should be inspected by naked eyes. | | | |
| 3 | Dielectric strength | Between lead wires | No failure. | The capacitor should not be damaged when DC voltage of 200% of the rated voltage are applied between the lead wires for 1 to 5 s. (Charge/Discharge current≤50mA.) | | | |
| | | Body insulation | No failure. | The capacitor is placed in the container with metal balls of diameter 1mm so that each lead wire, shortcircuited, is kept about 2mm off the balls as shown in the figure, and DC voltage of 1.3kV is applied for 1 to 5 s between capacitor lead wires and small metals. (Charge/Discharge current≤50mA.) | | | |
| 4 | Insulation Resistance (I.R.) | Between lead wires | 10 000M Ω min. | The insulation resistance should be measured with DC500±50V within 60±5 s of charging. | | | |
| 5 | Capacitance | | Within specified tolerance. | The capacitance should be measured at 20°C with 1±0.2kHz (Char. SL : 1±0.2MHz) and AC5V(r.m.s.) max | | | |
| 6 | Q Dissipation Factor | (D.E.) | Char. SL: 400+20C*2min. (30pF und 1000 min. (30pF min.) Char. B,E: 2.5% max. | The dissipation factor and Q should be measured | | | |
| 7 | Temperature chara | | Char. SL: +350 to - 1000ppm/ | °C The capacitance measurement should be made at | | | |
| | | | • | e stored at 85±2°C for 1 h, then placed at *1room h before initial measurements. (Char. B,E) 1 2 3 4 5 ±2 -25±3 20±2 85±2 20±2 | | | |
| 8 | Strength of lead | Pull | Lead wire should not cut off. Capacitor should not be broke | As shown in the figure at right, fix the body of the capacitor and apply a tensile weight gradually to each lead wire in the radial | | | |
| | Bending | | | direction of the capacitor up to 10N and keep it for 10±1 s. Each lead wire should be subjected to 5N of weight and bent 90° at the point of egress, in one direction then returned to its original position and bent 90° in the opposite direction at the rate of one bend in 2 to | | | |
| 9 | Vibration resistance | Appearance Capacitance | No marked defect. Within specified tolerance. | 3 s. The capacitor should be firmly soldered to the supporting lead wire and vibrated at a frequency | | | |
| | | Q D.F. | Char. SL: 400+20C*2min. (30pF und 1 000 min. (30pF min.) Char. B,E: 2.5% max. | range of 10 to 55Hz, 1.5mm in total amplitude, with about a 1min rate of vibration change from 10Hz to 55Hz and back to 10Hz. Apply for a total of 6 h; 2 h each in 3 mutually perpendicular directions. | | | |
| 10 | Solderability of lea | | Lead wire should be soldered with uniformly coated on the a direction over 3/4 of the circumferential direction. | The lead wire of a capacitor should be dipped into | | | |

^{*1 &}quot;room condition" lemperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

*2 "C" expresses nominal capacitance value (pF)

| N. | | | Reference only | Table 2011 | | | | | | |
|-----|---|------------------|--|--|--|--|--|--|--|--|
| No. | Ite | | Specification | Test method | | | | | | |
| 11 | Soldering effect | Appearance | No marked defect. | The lead wire should be immersed into the melted | | | | | | |
| | (Non-preheat) | Capacitance | Char. SL: Within ± 2.5% | solder of 350±10°C up to about 1.5 to 2.0mm from | | | | | | |
| | | change | Char. B: Within ± 5% | the main body for 3.5±0.5 s. | | | | | | |
| | | | Char. E: Within ± 15% | Pre-treatment : Capacitor should be stored at | | | | | | |
| | | Dielectric | Per item 3. | 85±2°C for 1 h, then placed at | | | | | | |
| | | strength | | *1room condition for 24±2 h before | | | | | | |
| | | (Between | | initial measurements. (Char. B,E) | | | | | | |
| | | lead wires) | | Post-treatment: Capacitor should be stored for 1 to | | | | | | |
| | | | | 2 h at *1room condition. (Char. SL) Post-treatment: Capacitor should be stored for 4 to | | | | | | |
| | | | | 24 h at *1room condition. (Char. B,E) | | | | | | |
| 12 | Soldering effect | Appearance | No marked defect. | First the capacitor should be stored at 120+0/-5°C | | | | | | |
| 12 | (On-preheat) | Capacitance | Char. SL: Within ± 2.5% | for 60+0/-5 s. | | | | | | |
| | (On picheat) | change | Char. B: Within ± 5% | Then, as in figure, the lead wires should be | | | | | | |
| | | Change | | immersed solder of 260+0/-5°C up to 1.5 to 2.0mm | | | | | | |
| | | Dielectric | Char. E: Within ± 15% Per item 3. | from the root of terminal for 7.5+0/-1 s. | | | | | | |
| | | strength | Per item 5. | | | | | | | |
| | | (Between | | Thermal | | | | | | |
| | | lead wires) | | insulating V 15 | | | | | | |
| | | load Wilco) | | to 2.0mm | | | | | | |
| | | | | | | | | | | |
| | | | | solder | | | | | | |
| | | | | | | | | | | |
| | | | | Pre-treatment : Capacitor should be stored at | | | | | | |
| | | | | 85±2°C for 1 h, then placed at | | | | | | |
| | | | | *1room condition for 24±2 h before | | | | | | |
| | | | | initial measurements. (Char. B,E) | | | | | | |
| | | | | Post-treatment : Capacitor should be stored for 1 to | | | | | | |
| | | | | 2 h at *1room condition. (Char. SL) | | | | | | |
| | | | | Post-treatment : Capacitor should be stored for 4 to | | | | | | |
| | | | | 24 h at *1room condition. | | | | | | |
| 13 | Humidity | Annogrange | No marked defect. | (Char. B,E) | | | | | | |
| 13 | (Under steady | Appearance | | Set the capacitor for 500 +24/-0 h at 40±2°C in 90 | | | | | | |
| | state) | Capacitance | Char. SL: Within ± 5% | to 95% relative humidity. | | | | | | |
| | siaie) | change | Char. B : Within ±10% | Pre-treatment : Capacitor should be stored at | | | | | | |
| | | | Char. E: Within ±20% | 85±2°C for 1 h, then placed at | | | | | | |
| | | Q | Char. SL : | *1room condition for 24±2 h before | | | | | | |
| | | | 275+5/2C*2min. (30pF under) | initial measurements. (Char. B,E) Post-treatment: Capacitor should be stored for 1 to | | | | | | |
| | | D.F. | 350 min. (30pF min.) Char. B,E: 5.0% max. | 2 h at *1 room condition. | | | | | | |
| | | I.R. | | Z ii di 100iii condition. | | | | | | |
| 1.4 | Llumidity loodin = | | 1 000MΩ min. | Applicable material contracts for 500 co.4/ 0 to 54.40 co.00 | | | | | | |
| 14 | Humidity loading | Appearance | No marked defect. | Apply the rated voltage for 500 +24/-0 h at 40±2°C | | | | | | |
| | | Capacitance | Char. SL: Within ± 7.5% | in 90 to 95% relative humidity. | | | | | | |
| | | change | Char. B: Within ±10% | (Charge/Discharge current≤50mA.) | | | | | | |
| | | | Char. E: Within ±20% | Pre-treatment : Capacitor should be stored at | | | | | | |
| | | Q | Char. SL: | 85±2°C for 1 h, then placed at | | | | | | |
| | | | 100+10/3C*2min. (30pF under) | *1room condition for 24±2 h before | | | | | | |
| | | DE | 200 min. (30pF min.) | initial measurements. (Char. B,E) | | | | | | |
| | | D.F. | Char. B,E : 5.0% max. | Post-treatment : Capacitor should be stored for 1 to 2 h at *1room condition. (Char. SL) | | | | | | |
| | | I.R. | 500M Ω min. | | | | | | | |
| | | | | Post-treatment : Capacitor should be stored at | | | | | | |
| | | | | 85±2°C for 1 h, then placed at | | | | | | |
| | | | | *¹room condition for 24±2 h. (Char. B,E) | | | | | | |
| *1 | "room oordition" T- | mporoturo: 45 to | 25°C Polotivo humiditus 45 to 75°C A | , , , | | | | | | |
| | *1 "room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa | | | | | | | | | |

^{*1 &}quot;room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa *2 "C" expresses nominal capacitance value (pF)

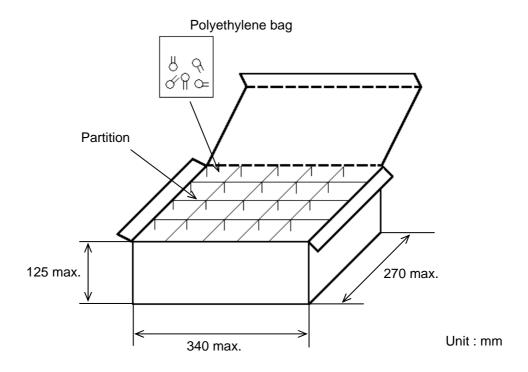
| | | | Neierence only | | | | | | |
|-----|---------------------|---------------------------|--|---|-----------------------------------|----------------------|--------------|-------------------|--|
| No. | Item | | Specification | Test method | | | | | |
| 15 | Life | Appearance | No marked defect. | Apply | a DC v | oltage of 150 | % of the | rated voltage | |
| | | Capacitance | Char. SL: Within ± 3% | for 1 000 +48/-0 h at 85±2°C, and relative humidity of 50% max (Charge/Discharge current≤50mA | | | | elative humidity | |
| | | change | Char. B : Within ±10% | | | | | | |
| | | | Char. E: Within ±20% | Pre-t | reatmen | t : Capacitor | should b | e stored at | |
| | | Q | Char. SL: | | | | | n placed at | |
| | | | 275+5/2C*2min. (30pF under) | | | *1room co | ndition fo | r 24±2 h before | |
| | | | 350 min. (30pF min.) | | | | | ts. (Char. B,E) | |
| | | D.F. | Char. B,E: 4.0% max. | Post- | treatme | | | e stored for 1 to | |
| | | I.R. | 2000M $Ω$ min. | Б. | | | | tion. (Char. SL) | |
| | | | | Post- | treatme | nt : Capacitor | | | |
| | | | | | | | | n placed at | |
| | | | | | | *1room co | | r 24±2 n. | |
| 16 | Tomoroturo | Annogranos | No marked defect. | Tho | onosito | (Char. B, | | to 5 temperature | |
| 10 | Temperature and | Appearance Capacitance | | | | | | ersion cycles. | |
| | Immersion cycle | change | Char. SL: Within ± 3% | Cycle | s, men c | Consecutively | 10 2 1111111 | ersion cycles. | |
| | Illinicision cycle | Change | Char. B: Within ±10% Char. E: Within ±20% | -Ten | neratur | e cycle> | | | |
| | | | | 1011 | | | (0.0) | Time | |
| | | Q | Char. SL: | | Step | Temperatu | | Time | |
| | | | 275+5/2C*2min. (30pF under) | | 1 | -25±3 | | 30 min | |
| | | D.F. | 350 min. (30pF min.) Char. B,E: 4.0% max. | | 2 | Room Te | | 3 min | |
| | | I.R. | 2000MΩ min. | | 3 | +85±3 | | 30 min | |
| | | Dielectric | Per item 3. | | 4 | Room Te | | 3 min | |
| | | strength | Per item 5. | | | Cycle time : 5 cycle | | | |
| | | (Between | | <lmn< td=""><td>nersion o</td><td>cycle></td><td></td><td></td></lmn<> | nersion o | cycle> | | | |
| | | lead wires) | | Ste | Tem | perature(°C) | Time | Immersion water | |
| | | | | 1 | 4 | -65+5/-0 | 15 min | Clean water | |
| | | | | 2 | | 0.10 | 45 : | Salt | |
| | | | | 2 | | 0±3 | 15 min | water | |
| | | | | Cycle time : 2 cycle | | | | | |
| | | | | Pre-treatment : Capacitor should be stored at | | | | | |
| | | | | 85±2°C for 1 h, then placed a | | | | | |
| | | | | | | | | • | |
| | | | | | initial measurements. (Char. B,E) | | | | |
| | | | | Post- | treatme | | | | |
| | | | | Post-treatment: Capacitor should be stored for 4 to 24 h at *1room condition. | | | | | |
| *1 | "room condition" Te | mnerature: 15 to | 35°C. Relative humidity: 45 to 75%. A | tmoen | noric nre | | | | |

^{*1 &}quot;room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa *2 "C" expresses nominal capacitance value (pF)

6. Packing specification

•Bulk type (Packing style code : B)

The size of packing case and packing way



The number of packing = *1 Packing quantity \times *2 n

*1 : Please refer to [Part number list].

*2 : Standard n = 20 (bag)

Note)

The outer package and the number of outer packing be changed by the order getting amount.

EU RoHS RoHS指令への対応

This products of the following crresponds to EU RoHS 当製品は以下の欧州RoHSに対応しています。

(1) RoHS

EU RoHs 2011/65/EC compliance 2011/65/EC(改正RoHS指令)に対応

maximum concentration values tolerated by weight in homogeneous materials

- •1000 ppm maximum Lead
- •1000 ppm maximum Mercury
- •100 ppm maximum Cadmium
- •1000 ppm maximum Hexavalent chromium
- •1000 ppm maximum Polybrominated biphenyls (PBB)
- •1000 ppm maximum Polybrominated diphenyl ethers (PBDE)

鉛:1000ppm以下 水銀:1000ppm以下 カドミウム:100ppm以下 六価クロム:1000ppm以下

ポリ臭化ビフェニル(PBB): 1000ppm以下

ポリ臭化ジフェニルエーテル(PBDE): 1000ppm以下